

Docket No.: WMP-IFT-699

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : MATTHIAS STECHER ET AL.
Filed : CONCURRENTLY HEREWITH
Title : SOI COMPONENT



INFORMATION DISCLOSURE STATEMENT

Hon. Commissioner of Patents and Trademarks,
Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

U.S. Patent 6,153,912 (Holst), dated November 28, 2000;

German Published Non-Prosecuted Patent Application DE 197 02 102 A1 (Fujihira et al.), dated July 24, 1997, semiconductor device and method for fabricating the semiconductor device;

European Patent Application 0 497 427 A2 (Merchant et al.), dated August 5, 1992.

If no translation of pertinent portions of any foreign language patents or publications mentioned above is included with the aforementioned copies of those applications, patents and/or publications, it is because no existing translation is readily available to the applicant.

Respectfully submitted,

[Signature]

For Applicants

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